APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention

METHOD AND STRUCTURE FOR HEAT SINK ATTACHMENT IN SEMICONDUCTOR DEVICE PACKAGING

Application Type: regular, utility

Attorney Docket Number: FIS920030398US1

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Customer Number: 29371



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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

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